

Description

The G2301C is a three-phase 40V, high speed pre-driver for power P/N MOSFET.

It has two inputs for high side and low side, and two outputs per channel with internal dead time to avoid cross-conduction.

The input logic level is compatible with 3.3V/5V/15V signal. Output 10V gate voltage for both PMOS and NMOS.

It also built in a 5V/40mA LDO for MCU or other device power supply, and have thermal shut down protection for safety.

Features

- Three-phase outputs for P/N MOS half-bridge
- Operation supply range from 8V to 40V
- Independent input for high side and low side
- Output 10V V_{GS} for both PMOS and NMOS
- 3.3V, 5V and 15V input logic compatible
- Built-in 5V/40mA LDO
- Built-in dead time
- Built-in TSD
- Available in ESOP16 package

Applications

- H-bridge
- Inverter

Typical Application

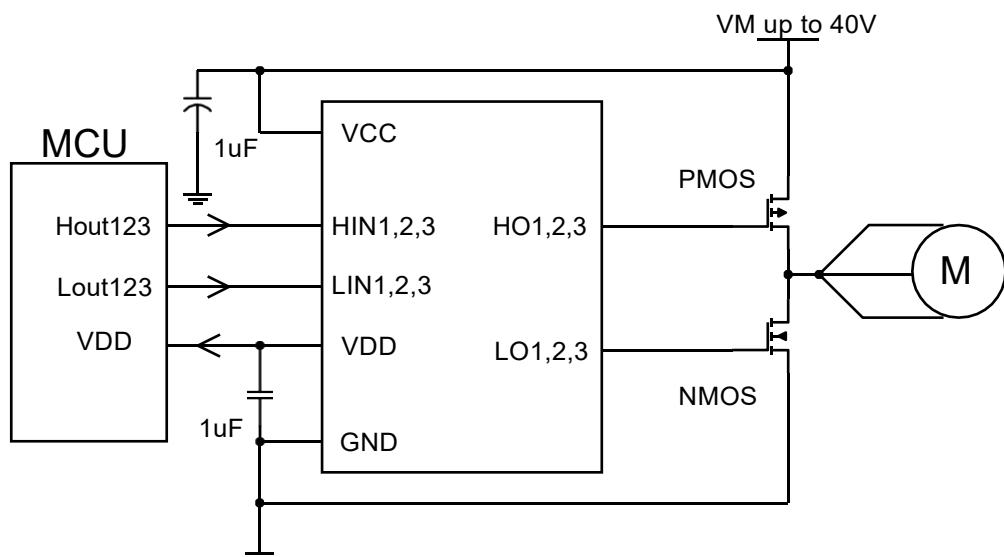


Figure 1. Schematic Diagram

Ordering Information

Part Number	Package	Package Method	Marking
G2301C	ESOP16	Tape 3,000 pcs/Reel	G2301 XXXXXYX XXWWX

Pin Configuration and Marking Information

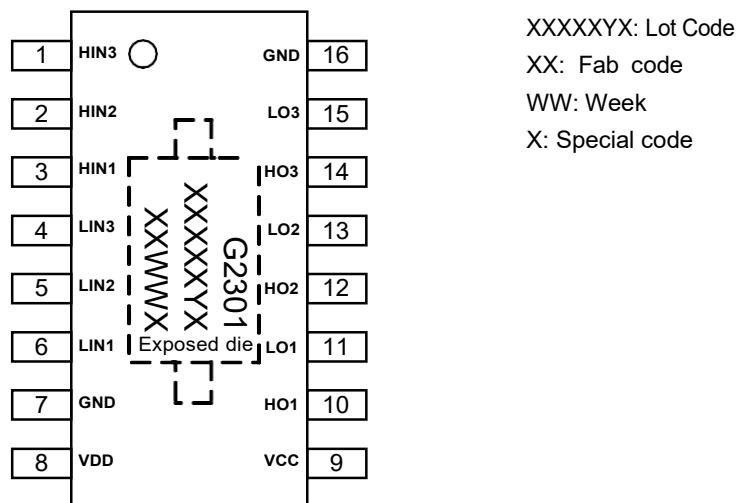


Figure2 : Pin configuration

Pin Definition

Pin No.	Name	Description
1	HIN3	Logic input for high side channel 3
2	HIN2	Logic input for high side channel 2
3	HIN1	Logic input for high side channel 1
4	LIN3	Logic input for low side channel 3
5	LIN2	Logic input for low side channel 2
6	LIN1	Logic input for low side channel 1
7	GND	Ground, short to pin 16 internally
8	VDD	5V LDO reference output, 1uF bypass cap to ground
9	VCC	Power supply voltage, bypass cap to ground
10	HO1	High side driver output channel 1
11	LO1	Low side driver output channel 1
12	HO2	High side driver output channel 2
13	LO2	Low side driver output channel 2
14	HO3	High side driver output channel 3
15	LO3	Low side driver output channel 3
16	GND	Ground, short to pin 7 internally
	Exposed Pad	Not connect internally, suggest connecting to ground as PCB heatsink

Absolute Maximum Ratings (Note 1)

Symbol	Parameters	Range	Units
V _{CC}	Power supply voltage	-0.3 ~ 40	V
V _{DD}	LDO output voltage	-0.3 ~ 6	V
I _{VDD}	LDO output current	-0.3 ~ 50	mA
V _{IN}	Input voltage (V _{HIN} , V _{LIN})	-0.3 ~ 20	V
V _{HO}	High side output voltage	V _{CC} -15 ~ V _{CC}	V
V _{LO}	Low side output voltage	-0.3 ~ 15	V
P _{DMAX}	Package power dissipation (note 2)	1.4	W
θ _{JA}	Thermal resistance, junction to ambient	89	°C/W
θ _{Jc}	Thermal resistance, junction to case	40	°C/W
T _J	Junction temperature	-40 ~ 150	°C
T _{STG}	Storage temperature	-55 ~ 150	°C

Note 1: Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. Under recommended operating conditions the device operation is assured, but some particular parameter may not be achieved. The electrical characteristics table defines the operation range of the device, the electrical characteristics is assured on DC and AC voltage by test program. For the parameters without minimum and maximum value in the EC table, the typical value defines the operation range, the accuracy is not guaranteed by spec.

Note 2: The maximum power dissipation decrease if temperature rise, it is decided by TJMAX, θJA, and environment temperature (TA). The maximum power dissipation is the lower one between PDMAX = (TJMAX - TA) / θJA and the number listed in the maximum table.

Recommended Operation Conditions

Symbol	Parameters	Range	Units
V _{CC}	Power supply voltage	8 ~ 28	V
I _{VDD}	LDO output current (V _{CC} =8V~28V)	0 ~ 35	mA
C _{VDD}	VDD bypass capacity	0.47 ~ 2.2	uF
V _{IN(ON)}	Input ON Threshold Voltage	2.9 ~ V _{CC}	V
V _{IN(OFF)}	Input OFF Threshold Voltage	0 ~ 0.4	V
T _{DEAD}	MCU input dead time	0.5	us
F _{PWM}	PWM Switching Frequency	50	kHZ

Electrical Characteristics (Notes 3) (Unless otherwise specified, $V_{CC} = 24V$ and $T_A = 25^\circ C$)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics						
V_{CC_ON}	V_{CC} under voltage rising threshold		5.8	6.5	7.4	V
V_{CC_UVLO}	V_{CC} under voltage falling threshold		5.4	6.0	6.8	V
V_{CC_HYS}	V_{CC} under voltage hysteresis voltage		0.3	0.5	0.8	V
I_{QCC}	Quiescent V_{CC} supply current	$V_{IN}=0V$	0.3	0.5	1.0	mA
V_{DD}	VDD output voltage		4.7	5.0	5.3	V
V_{IH}	Logic 1 input trigger voltage		2.2	-	-	V
V_{IL}	Logic 0 input trigger voltage		-	-	0.6	V
$I_{ISOURCE}$	Logic 1 input bias current	$V_{IN}=5V$	-	32	100	uA
I_{ISINK}	Logic 0 input bias current	$V_{IN}=0V$	-	-	1.0	uA
V_{HO}	HO output voltage	$H_{IN}=5V$	VCC- 11	VCC- 9.5	VCC- 8	V
V_{LO}	LO output voltage	$L_{IN}=5V$	8.5	10	11.5	V
I_{HO+}	PMOS turn-on current	$H_O=V_{CC}$	-	35	-	mA
I_{HO-}	PMOS turn-off current	$H_O=V_{CC}-10V$	-	300	-	mA
I_{LO+}	NMOS turn-on current	$L_O=0V$	-	60	-	mA
I_{LO-}	NMOS turn-off current	$L_O=10V$	-	300	-	mA
T_{SD}	TSD Temperature		-	150	-	°C
$T_{RECOVER}$	TSD release temperature		-	135	-	°C
Dynamic Characteristics (Note4)						
t_{on}	Turn-on propagation delay		-	80	-	ns
t_{off}	Turn-off propagation delay		-	30	-	ns
t_{Hr}	HO rise time		-	50	-	ns
t_{Hf}	HO fall time		-	400	-	ns
t_{Lr}	LO rise time		-	200	-	ns
t_{Lf}	LO fall time		-	50	-	ns
DT	Dead time		-	100	-	ns

Note 3: The maximum and minimum parameters specified are guaranteed by test, the typical value are guaranteed by design, characterization and statistical analysis.

Note 4: All dynamic electrical characteristics are related to PCB layout.

Internal Block Diagram

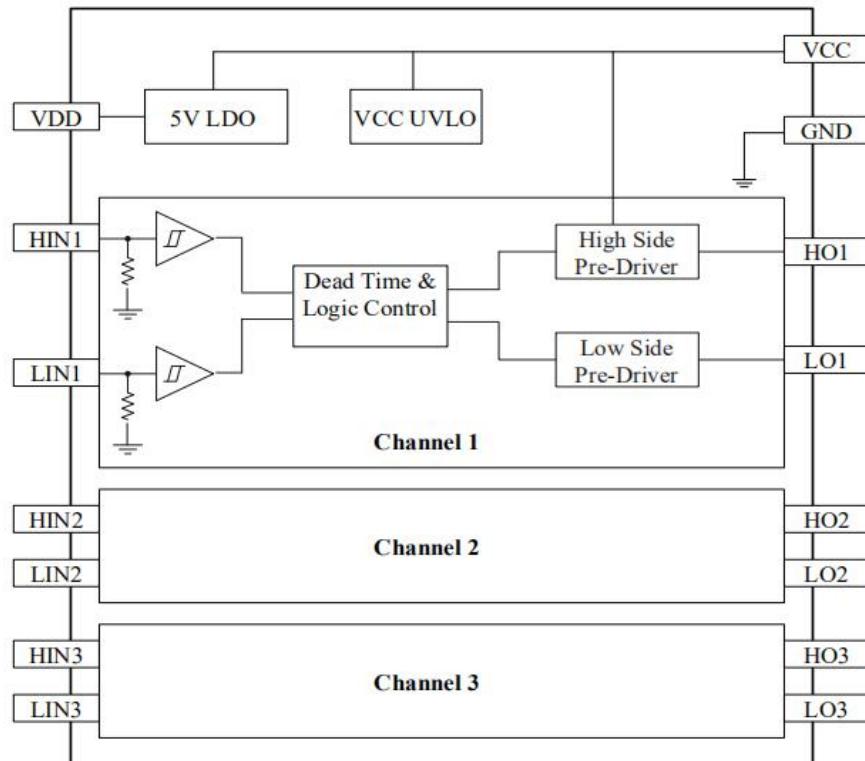


Figure3 : Internal block diagram

True Table

HIN	LIN	UVLO/TSD	HO	LO
0	0	0	OFF	OFF
0	1	0	OFF	ON
1	0	0	ON	OFF
1	1	0	OFF	OFF
X	X	1	OFF	OFF

Note:

- 1) X=Don't Care 1=High 0=Low
- 2) HO: ON=VCC-10V, OFF=VCC; LO: ON=10V, OFF=0V

Waveforms

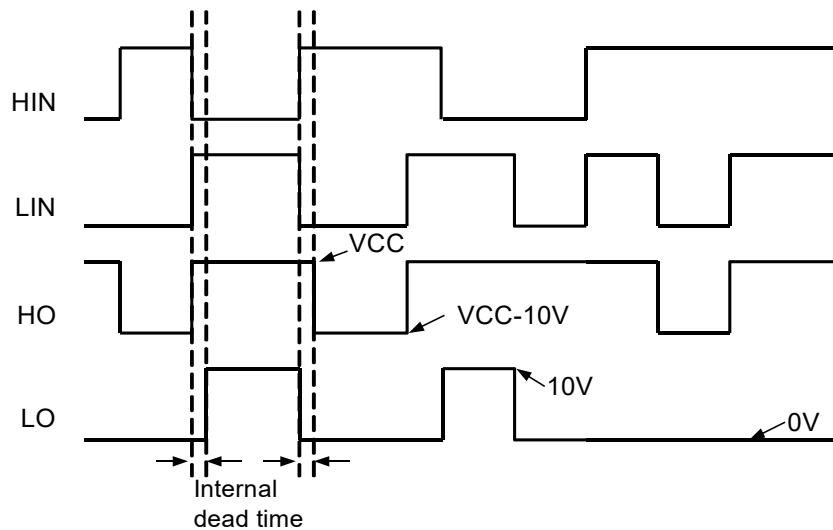


Figure 4. Input/ Output Timing Diagram

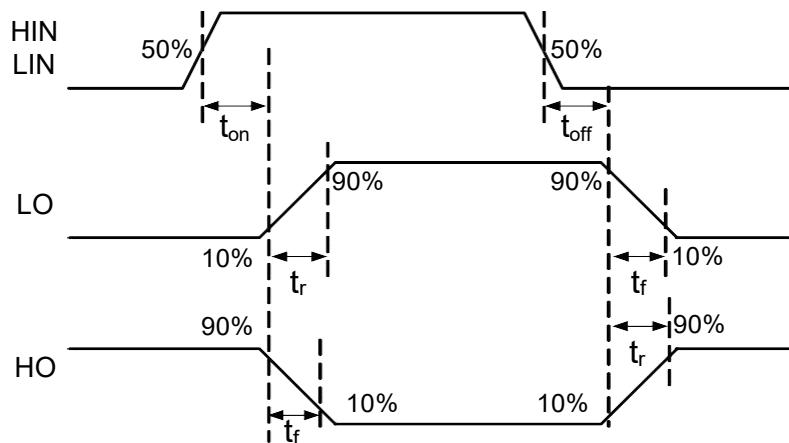


Figure 5. Switching Timing Waveforms

Application Information

The G2301 integrating a 5V LDO, is a P/N MOS driver and built-in under-voltage protection and thermal shut down protection.

1. Start Up

Aftersystem powered on, when the VCC pin voltage reaches the turn on threshold, the internal circuits start working. Output of LDO raises gradually, until it is steady at 5V.

2. TSD

Once the temperature is more than 150°C the chip will shut down all outputs except LDO. When it is below 135°C the chip recovers to normal operating station.

3. MOS drive

In general, G2301 can drive most of P/N MOS directly. Sometimes it is necessary to add appropriate MOS gate resistor.

If capacitance load is less than 250pF, there is more than 1V overshoot voltage.

4. Input and output

G2301 is built-in dead time, so that it cannot turn on PMOS and NMOS at the same time. The input pins only identify above 200ns pulse width.

5. PCB Layouts

Firstly, bypass capacity of VCC and VDD must be placed next to the pin as close as possible and both of 1uF value is recommended.

Secondly, exposed pad could define as ground and use for heat sink.

Typical Performance Characteristics

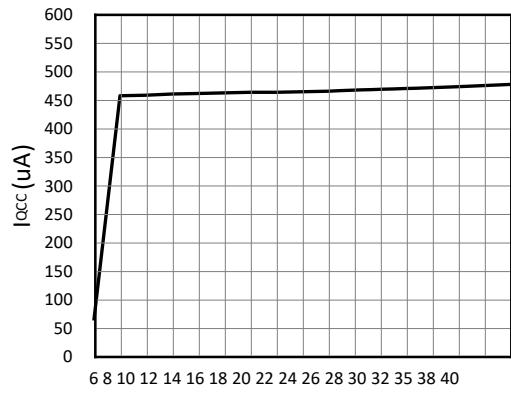


Figure 6 I_{QCC} vs. V_{CC}

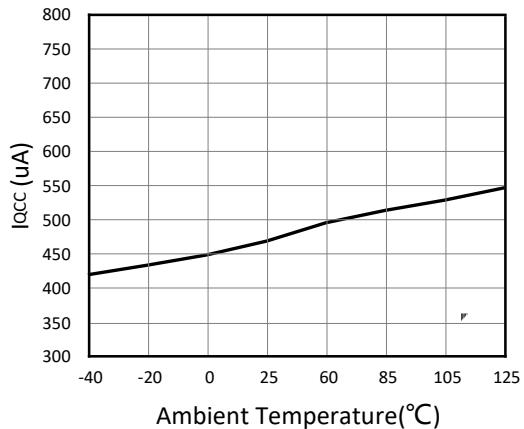


Figure 7 I_{QCC} vs. Temperature

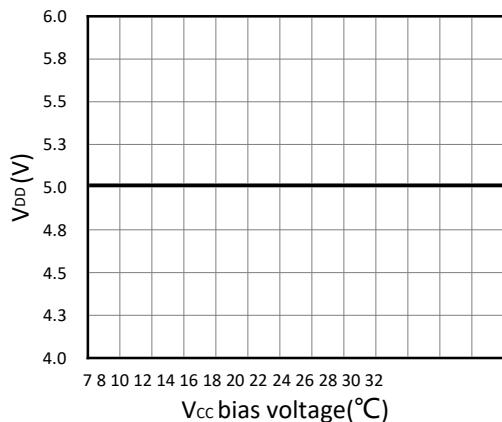


Figure 8 V_{DD} vs. V_{CC}

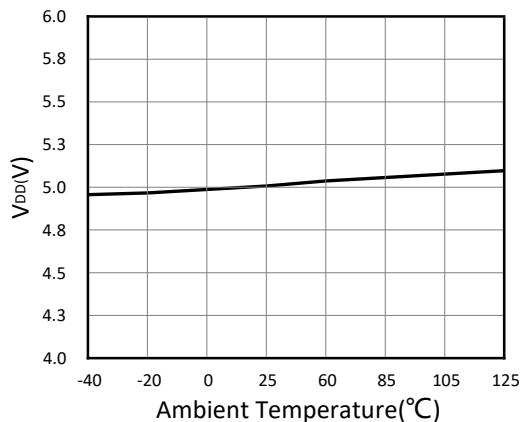


Figure 9 V_{DD} vs. Temperature

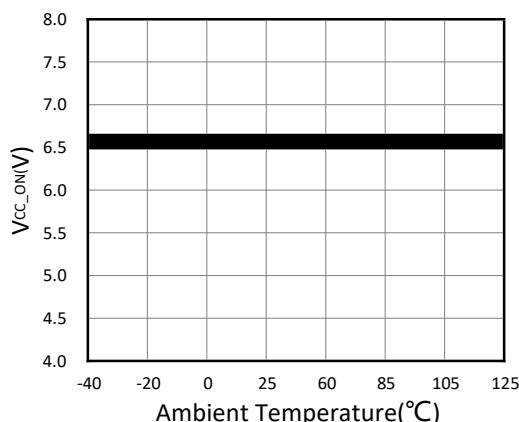


Figure 10 V_{CC_ON} vs. Temperature

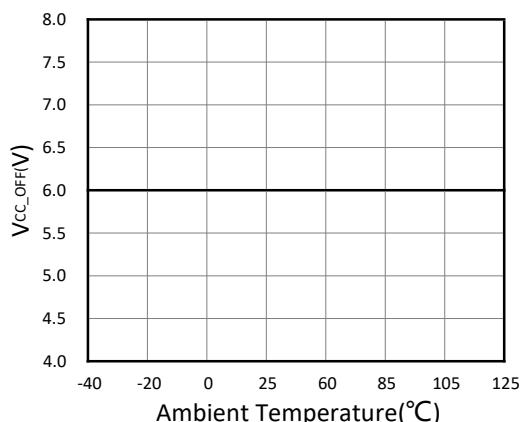


Figure 11 V_{CC_OFF} vs. Temperature

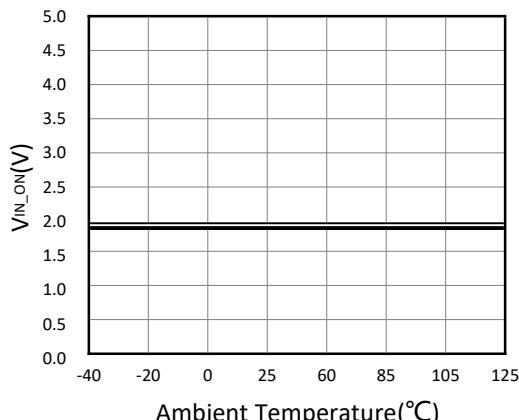


Figure 12 V_{IN_ON} vs. Temperature

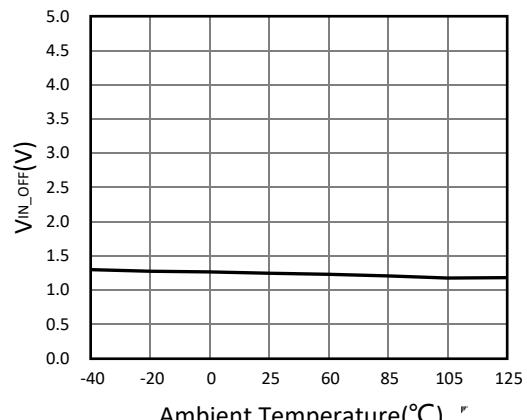


Figure 13 V_{IN_OFF} vs. Temperature

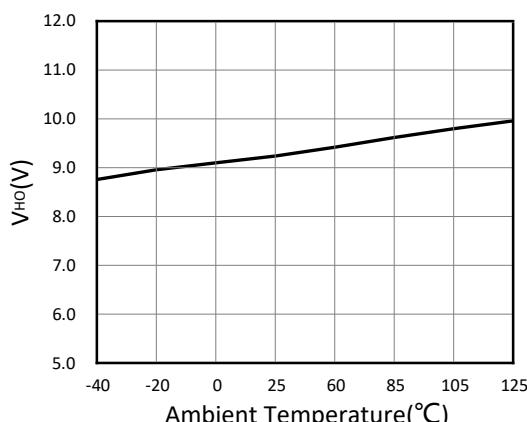


Figure 14 V_{HO} vs. Temperature

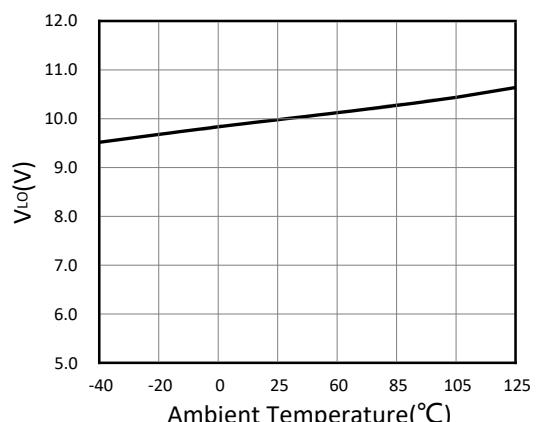
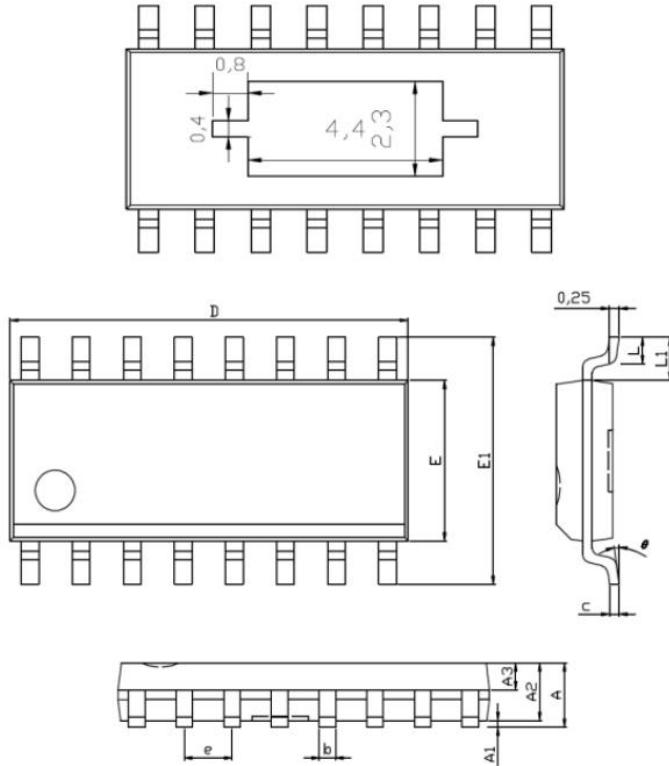


Figure 15 V_{LO} vs. Temperature

Physical Dimensions



Symbol	Dimensions In Millimeters	
	Min.	Max.
A		1.57
A1	0.00	0.07
A2	1.40	1.50
A3	0.61	0.71
b	0.39	0.45
c	0.51	0.26
D	9.70	10.10
E	3.70	4.10
E1	5.80	6.20
e	1.24	1.30
L	0.60	0.80
L1	0.99	1.10
θ	0°	8°



G2301C

3-Phase 40V P/N MOS Pre-driver with LDO

Revision Information

Revision	Date	Notes
1.0	2020-12	Initial version



G2301C

3-Phase 40V P/N MOS Pre-driver with LDO
